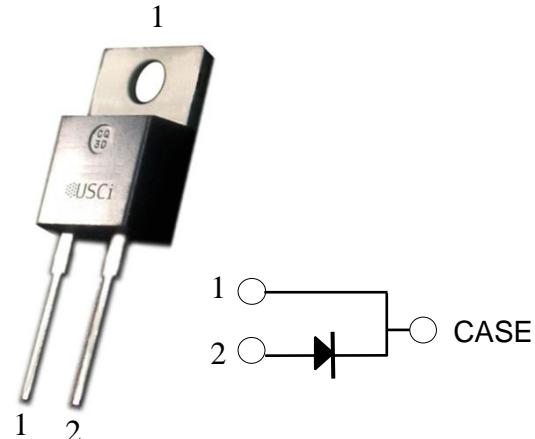


## Features

- Positive temperature coefficient for safe operation and ease of paralleling
- 175°C maximum operating junction temperature
- Extremely fast switching not dependent on temperature
- Essentially no reverse or forward recovery
- Enhanced surge capability

## Typical Applications

- Power converters
- Industrial motor drives
- Switching-mode power supplies
- Power factor correction modules



Part Number	Package	Marking
<b>UJD06510TS</b>	<b>TO-220-2</b>	<b>UJD06510TS</b>

## Descriptions

United Silicon Carbide, Inc offers the xR series of high-performance SiC Schottky diodes. With zero reverse recovery charge and 175°C maximum junction temperature, USCI's diodes are ideally suited for high-frequency and high-efficiency power systems with minimum cooling requirements.

## Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
DC Blocking Voltage	$V_{DC}$		650	V
Repetitive Peak Reverse Voltage, $T_j=25^\circ C$	$V_{RRM}$		650	V
Surge Peak Reverse Voltage	$V_{RSM}$		650	V
Maximum DC Forward Current	$I_F$	$T_C = 147^\circ C$	10	A
Non-Repetitive Forward Surge Current	$I_{FSM}$	$T_C = 25^\circ C, 8.3ms$ Half Sine Pulse	75	A
Non-Repetitive Peak Forward Current	$I_{F,max}$	$T_C = 25^\circ C, 10\mu s$	455	A
Non-Repetitive Avalanche Energy	$E_{AS}$	$T_j = 25^\circ C, L = 5mH,$ $I_{pk}=5.5A, V_{DD}=100V$	84	mJ
Power Dissipation	$P_{Tot}$	$T_C = 25^\circ C$ $T_C = 147^\circ C$	125 23	W
Maximum Junction Temperature	$T_{j,max}$		175	°C
Operating and Storage Temperature	$T_j, T_{STG}$		-55 to 175	°C

## Electrical Characteristics

$T_J = +25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Forward Voltage	$V_F$	$I_F = 10\text{A}, T_J = 25^\circ\text{C}$	-	1.5	1.7	V
		$I_F = 10\text{A}, T_J = 150^\circ\text{C}$	-	1.8	2.1	
		$I_F = 10\text{A}, T_J = 175^\circ\text{C}$	-	1.95	2.25	
Reverse Current	$I_R$	$V_R = 650\text{V}, T_J = 25^\circ\text{C}$	-	25	250	$\mu\text{A}$
		$V_R = 650\text{V}, T_J = 175^\circ\text{C}$	-	50	800	
Total Capacitive Charge	$Q_C$	$V_R = 400\text{V}, I_F = 10\text{A},$ $dI/dt = 250\text{A}/\mu\text{s}$		16		nC
Total Capacitance	C	$V_R = 1\text{V}, f = 1\text{MHz}$		290		pF
		$V_R = 300\text{V}, f = 1\text{MHz}$		31		
		$V_R = 600\text{V}, f = 1\text{MHz}$		28		

## Thermal characteristics

Parameter	symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Thermal Resistance	$R_{\theta JC}$				1.2	°C/W

## Typical Performance

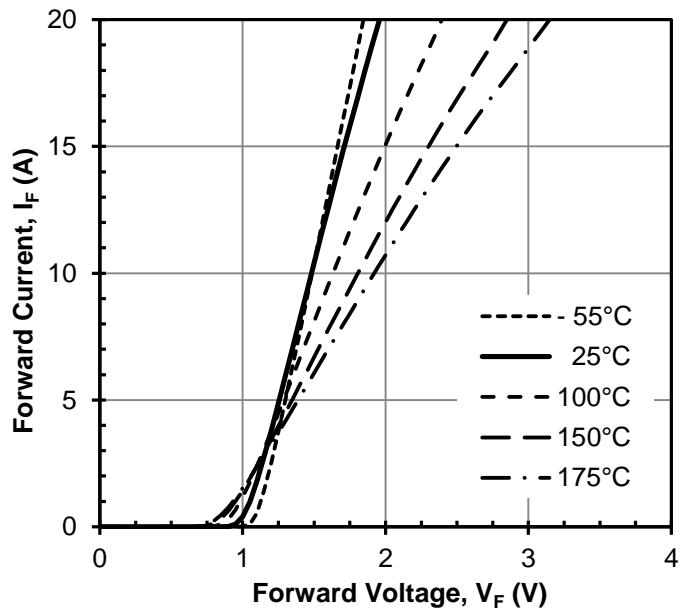
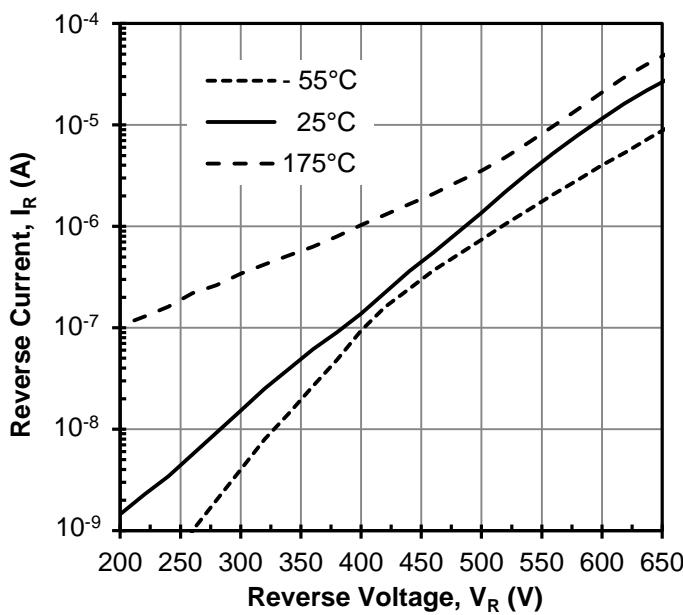
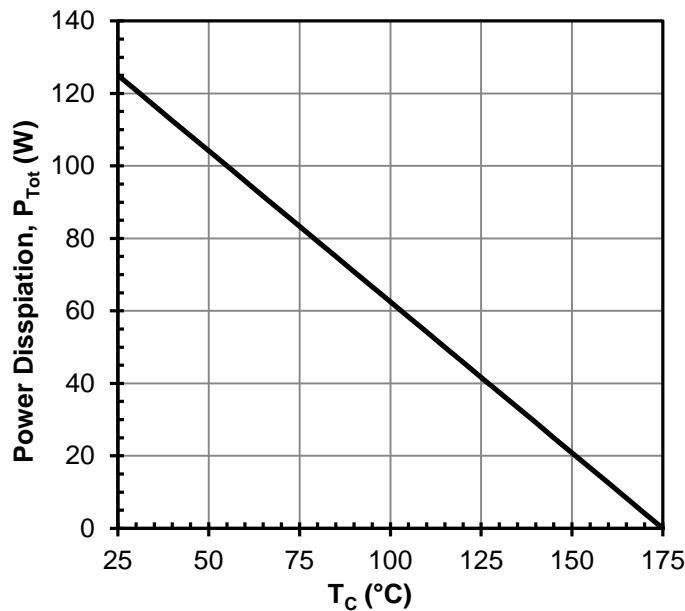
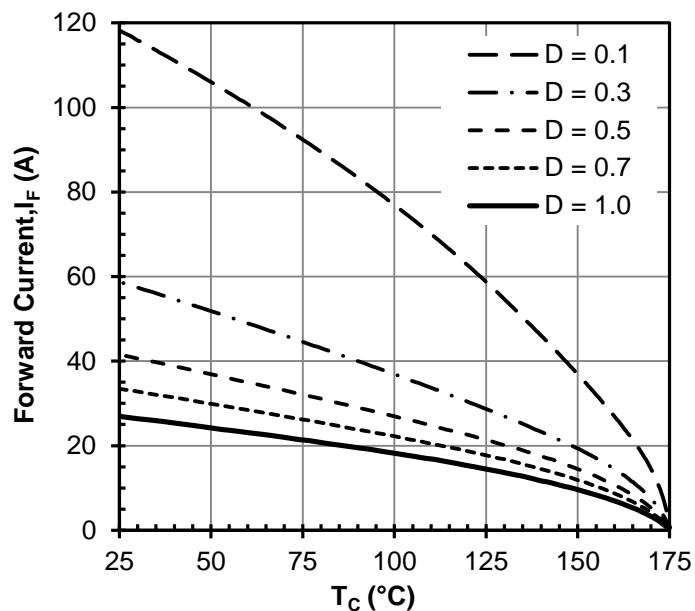


Figure 1 Typical reverse characteristics

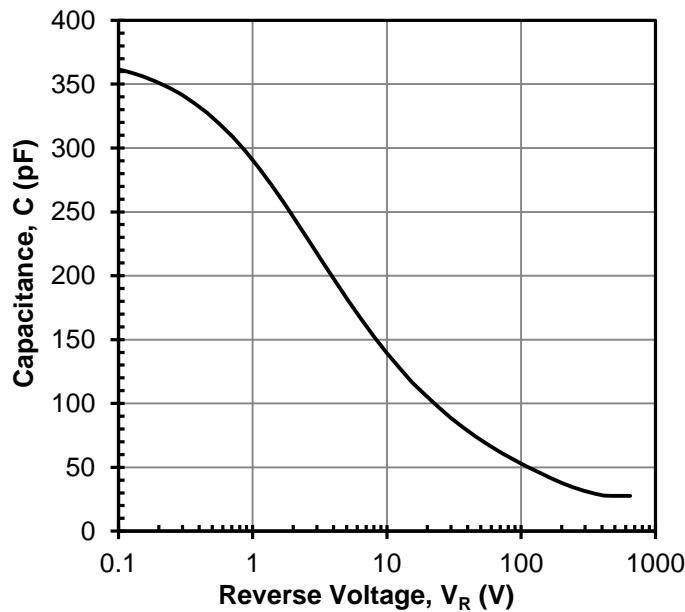
Figure 2 Typical forward characteristics



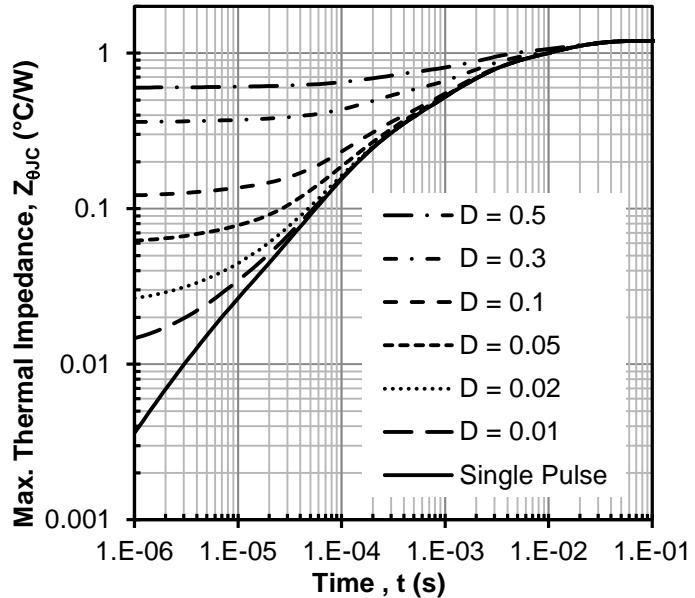
**Figure 3 Power dissipation**



**Figure 4 Diode forward current**

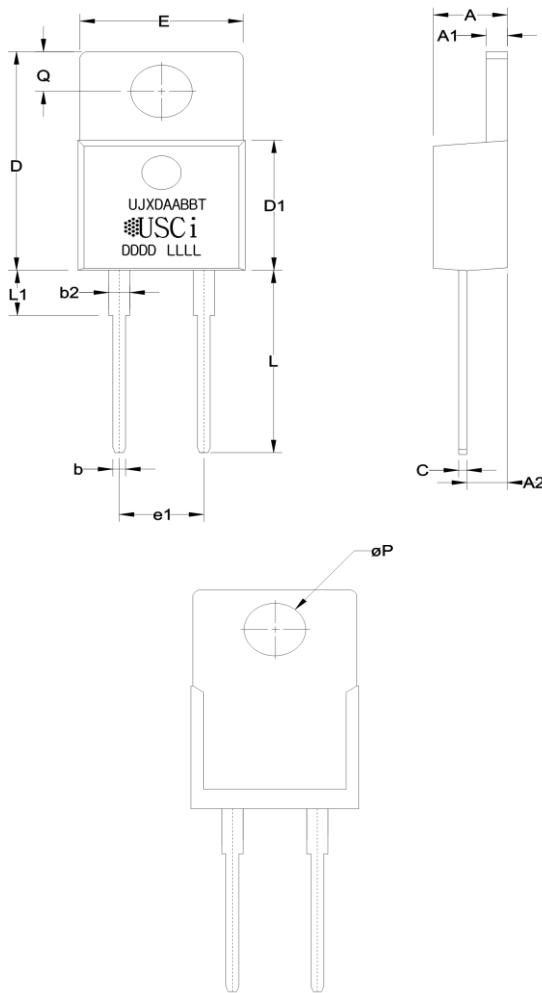


**Figure 5 Capacitance vs. reverse voltage**



**Figure 6 Maximum transient thermal impedance**

## Mechanical Characteristics



DIM	INCHES		MILLIMETERS	
	min	max	min	max
A	0.165	0.185	4.19	4.70
A1	0.048	0.052	1.22	1.32
A2	0.094	0.098	2.39	2.49
b	0.025	0.035	0.64	0.89
b2	0.045	0.055	1.14	1.40
C	0.018	0.025	0.46	0.64
D	0.595	0.615	15.11	15.62
D1	0.355	0.365	9.02	9.27
E	0.381	0.391	9.68	9.93
e1	0.198	0.202	5.03	5.13
L	0.5	0.51	12.70	12.95
L1	0.12	0.15	3.05	3.81
ØP	0.143	0.147	3.63	3.73
Q	0.1	0.12	2.54	3.05

<b>Mounting</b>	<b>M3/M3.5</b>	<b>1Nm</b>
<b>Torque</b>	<b>Screw</b>	<b>8.8 lbf-in</b>

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